Docket No. SB-101US

## Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named invento	r, I hereby declare tha	at:	
My residence, post office a	ıddress and citizenshi	ip are as stated below next to m	ny name,
	lural names are listed	r (if only one name is listed belo I below) of the subject matter w d	
the specification of which			·
(check one)			
☑ is attached hereto.			
was filed on		as United States Application No	. or PCT International
Application Number			
and was amended on			
		(if applicable)	
I hereby state that I have including the claims, as an		and the contents of the above diment referred to above.	identified specification,
1.56, including for contin	uation-in-part applica the prior application a	which is material to patentability ations, material information whand the national or PCT interna	nich became available
application(s) for patent, or application which designated below and have also ide	or plant breeder's rig ted at least one cou ntified below, by ch 's rights certificate(s)	35 U.S.C. 119(a)-(d) or (f), or hts certificate(s), or 365(a) of intry other than the United Statecking the box, any foreign a content of the	any PCT International ites of America, listed application for patent,
Prior Foreign Application(s	)		Priority Not Claimed
(Number)	(Country)	(Day/Month/Year Filed)	Ц
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	<u> </u>

Form PTO-SB-01 (9-95) (Modified)

P02/REV02

I hereby claim the benefit unde application(s) listed below:	er 35 U.S.C. Section 119(e)	of any United States provisional
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
Section 365(c) of any PCT Internations insofar as the subject matter of elunited States or PCT International U.S.C. Section 112, I acknowledge Office all information known to in	ational application designating each of the claims of this appal application in the manner proge the duty to disclose to the Lone to be material to patentabile ble between the filing date of the contents of the contents of the patents.	any United States application(s), or the United States, listed below and, lication is not disclosed in the prior rovided by the first paragraph of 35 Jnited States Patent and Trademark ity as defined in Title 37, C. F. R., he prior application and the national
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or ag nt(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (fist name and registration number)

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